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Zilog - Z8S18020VEC1960 Datasheet



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Applications of **Embedded - Microprocessors**

Embedded microprocessors are utilized across a broad spectrum of applications, making them indispensable in

Details

Details	
Product Status	Obsolete
Core Processor	Z8S180
Number of Cores/Bus Width	1 Core, 8-Bit
Speed	20MHz
Co-Processors/DSP	-
RAM Controllers	DRAM
Graphics Acceleration	No
Display & Interface Controllers	-
Ethernet	-
SATA	-
USB	-
Voltage - I/O	5.0V
Operating Temperature	-40°C ~ 100°C (TA)
Security Features	-
Package / Case	68-LCC (J-Lead)
Supplier Device Package	68-PLCC
Purchase URL	https://www.e-xfl.com/product-detail/zilog/z8s18020vec1960

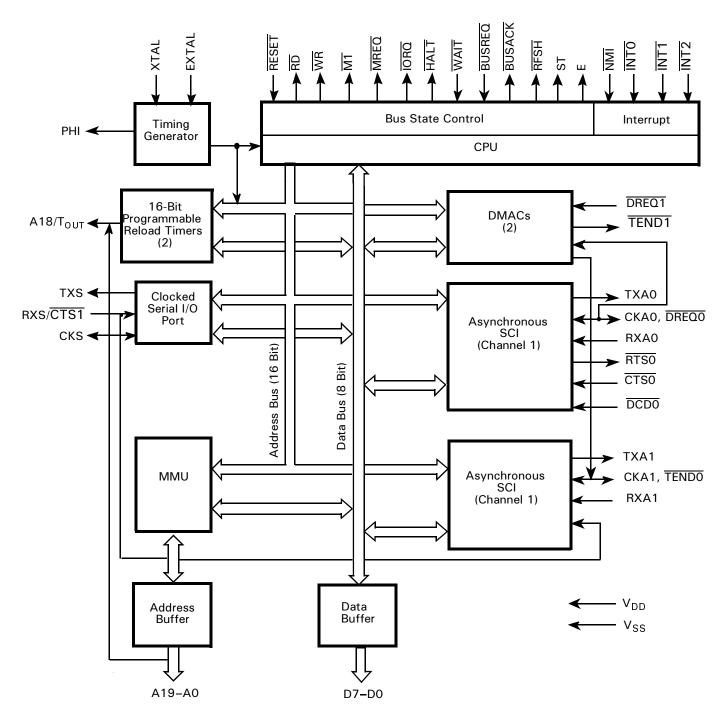
Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

GENERAL DESCRIPTION (Continued)

Power connections follow the conventional descriptions below:

Connection	Circuit	Device	
Power	V _{CC}	V _{DD}	
Ground	GND	V _{SS}	





PIN IDENTIFICATION (Continued)

Table 1.	Z8S180/Z8L180 Pir	n Identification (Continued)
10010 11	200100/20210011	raonanou (contanaou)

Pin Num	ber and Packa	ige Type	Default	Secondary	
QFP	PLCC	DIP	Function	Function	Control
13	19	17	A4		
14			NC		
15	20	18	A5		
16	21	19	A6		
17	22	20	A7		
18	23	21	A8		
19	24	22	A9		
20	25	23	A10		
21	26	24	A11		
22			NC		
23			NC		
24	27	25	A12		
25	28	26	A13		
26	29	27	A14		
27	30	28	A15		
28	31	29	A16		
29	32	30	A17		
30			NC		
31	33	31	A18	T _{OUT}	Bit 2 or Bit 3 of TCR
32	34	32	V _{DD}		
33	35		A19		
34	36	33	V _{SS}		
35	37	34	DO		
36	38	35	D1		
37	39	36	D2		
38	40	37	D3		
39	41	38	D4		
40	42	39	D5		
41	43	40	D6		
42			NC		
43			NC		
44	44	41	D7		
45	45	42	RTSO		
46	46	43	CTSO		
47	47	44	DCD0		
48	48	45	TXA0		
49	49	46	RXAO		
50	50	47	СКАО	DREQO	Bit 3 or Bit 5 of DMODE
51	-		NC		
52	51	48	TXA1		

Pin Num	ber and Packa	ige Type	Default	ult Secondary	
ΩFP	PLCC	DIP	Function	Function	Control
53	52		TEST		
54	53	49	RXA1		
55	54	50	CKA1	TENDO	Bit 4 of CNTLA1
56	55	51	TXS		
57	56	52	RXS	CTS1	Bit 2 of STAT1
58	57	53	CKS		
59	58	54	DREQ1		
60	59	55	TEND1		
61	60	56	HALT		
62			NC		
63			NC		
64	61	57	RFSH		
65	62	58	IORQ		
66	63	59	MREQ		
67	64	60	E		
68	65	61	M1		
69	66	62	WR		
70	67	63	RD		
71	68	64	PHI		
72	1	1	V _{SS}		
73	2		V _{SS}		
74	3	2	XTAL		
75			NC		
76	4	3	EXTAL		
77	5	4	WAIT		
78	6	5	BUSACK		
79	7	6	BUSREQ		
80	8	7	RESET		

Table 1. Z8S180/Z8L180 Pin Identification (Continued)

ARCHITECTURE

The Z180 combines a high-performance CPU core with a variety of system and I/O resources useful in a broad range of applications. The CPU core consists of five functional blocks: clock generator, bus state controller, Interrupt controller, memory management unit (MMU), and the central processing unit (CPU). The integrated I/O resources make up the remaining four functional blocks: direct memory access (DMA) control (2 channels), asynchronous serial communication interface (ASCI, 2 channels) programmable reload timers (PRT, 2 channels), and a clock serial I/O (CSI/O) channel.

Clock Generator. This logic generates a system clock from an external crystal or clock input. The external clock is divided by 2 or 1 and provides the timing for both internal and external devices.

Bus State Controller. This logic performs all of the status and bus-control activity associated with the CPU and some on-chip peripherals. Also includes wait-state timing, reset cycles, DRAM refresh, and DMA bus exchanges.

Interrupt Controller. This logic monitors and prioritizes the variety of internal and external interrupts and traps to provide the correct responses from the CPU. To maintain compatibility with the Z80 CPU, three different interrupts modes are supported.

Memory Management Unit. The MMU allows the user to map the memory used by the CPU (logically only 64KB) into the 1-MB addressing range supported by the Z8S180/Z8L180. The organization of the MMU object

Central Processing Unit. The CPU is microcoded to provide a core that is object-code compatible with the Z80 CPU. It also provides a superset of the Z80 instruction set, including 8-bit multiplication. The core is modified to allow many of the instructions to execute in fewer clock cycles.

DMA Controller. The DMA controller provides highspeed transfers between memory and I/O devices. Transfer operations supported are memory-to-memory, memory to/from I/O, and I/O-to-I/O. Transfer modes supported are request, burst, and cycle steal. DMA transfers can access the full 1-MB address range with a block length up to 64 KB, and can cross over 64K boundaries.

Asynchronous Serial Communication Interface (ASCI).

The ASCI logic provides two individual full-duplex UARTs. Each channel includes a programmable baud rate generator and modem control signals. The ASCI channels can also support a multiprocessor communication format as well as break detection and generation

Programmable Reload Timers (PRT). This logic consists of two separate channels, each containing a 16-bit counter (timer) and count reload register. The time base for the counters is derived from the system clock (divided by 20) before reaching the counter. PRT channel 1 provides an optional output to allow for waveform generation.

OPERATION MODES

Z80 versus 64180 Compatibility. The Z8S180/Z8L180 is descended from two different "ancestor" processors, ZiLOG's original Z80 and the Hitachi 64180. The Operating Mode Control Register (OMCR), illustrated in Figure 8, can be programmed to select between certain Z80 and 64180 differences.

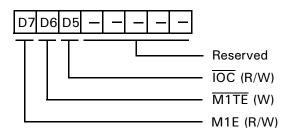


Figure 8. Operating Control Register (OMCR: I/O Address = 3EH)

M1E ($\overline{M1}$ Enable). This bit controls the $\overline{M1}$ output and is set to a 1 during RESET.

When M1E = 1, the $\overline{M1}$ output is asserted Low during opcode fetch cycles, Interrupt Acknowledge cycles, and the first machine cycle of an \overline{NMI} acknowledge.

On the Z8S180/Z8L180, this choice makes the processor fetch a RETI instruction one time. When fetching a RETI from a zero-wait-state memory location, the processor uses three clock bus cycles. These bus cycles are not fully Z80-timing compatible.

When M1E = 0, the processor does not drive $\overline{M1}$ Low during the instruction fetch cycles. After fetching a RETI instruction with normal timing, the processor goes back and refetches the instruction using fully Z80-compatible cycles that include driving $\overline{M1}$ Low. This option may be required by some external Z80 peripherals to properly decode the RETI instruction. Figure 9 and Table 5 show the RETI sequence when M1E is 0.

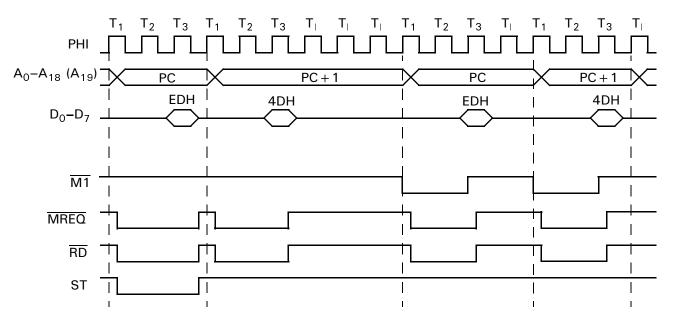
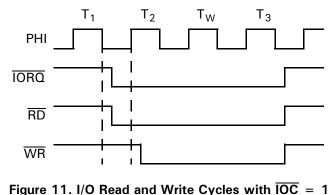
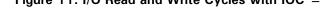
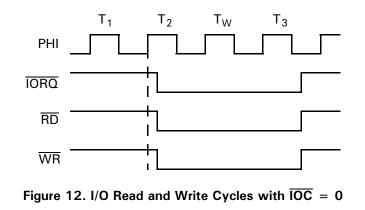


Figure 9. RETI Instruction Sequence with M1E = 0





When $\overline{\text{IOC}} = 0$, the timing of the $\overline{\text{IORQ}}$ and $\overline{\text{RD}}$ signals match the timing of the Z80. The $\overline{\text{IORQ}}$ and $\overline{\text{RD}}$ signals go active as a result of the rising edge of T2. (Figure 12.)



HALT and Low-Power Operating Modes. $Th\,e$

Z8S180/Z8L180 can operate in seven modes with respect to activity and power consumption:

- Normal Operation
- HALT Mode
- IOSTOP Mode
- SLEEP Mode
- SYSTEM STOP Mode
- IDLE Mode
- STANDBY Mode (with or without QUICK RECOV-ERY)

Normal Operation. In this state, the Z8S180/Z8L180 processor is fetching and running a program. All enabled functions and portions of the device are active, and the \overline{HALT} pin is High.

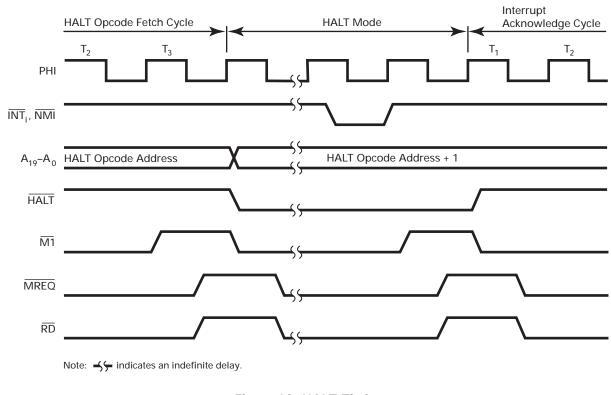
HALT Mode. This mode is entered by the HALT instruction. Thereafter, the Z8S180/Z8L180 processor continually fetches the following opcode but does not execute it and drives the HALT, ST and $\overline{M1}$ pins all Low. The oscillator and PHI pin remain Active. Interrupts and bus granting to external Masters, and DRAM refresh can occur, and all onchip I/O devices continue to operate including the DMA channels.

OPERATION MODES (Continued)

The Z8S180/Z8L180 leaves HALT mode in response to:

- Low on RESET
- Interrupt from an enabled on-chip source
- External request on NMI
- Enabled external request on INTO, INT1, or INT2

In case of an interrupt, the return address is the instruction following the HALT instruction. The program can either branch back to the HALT instruction to wait for another interrupt or can examine the new state of the system/application and respond appropriately.





SLEEP Mode. This mode is entered by keeping the IOSTOP bit (ICR5) and bits 3 and 6 of the CPU Control Register (CCR3, CCR6) all zero and executing the SLP instruction. The oscillator and PHI output continue operating, but are blocked from the CPU core and DMA channels to reduce power consumption. DRAM refresh stops, but interrupts and granting to an external Master can occur. Except when the bus is granted to an external Master, A19–0 and all control signals except HALT are maintained High. HALT is Low. I/O operations continue as before the SLP instruction, except for the DMA channels.

The Z8S180/Z8L180 leaves SLEEP mode in response to a Low on RESET, an interrupt request from an on-chip source,

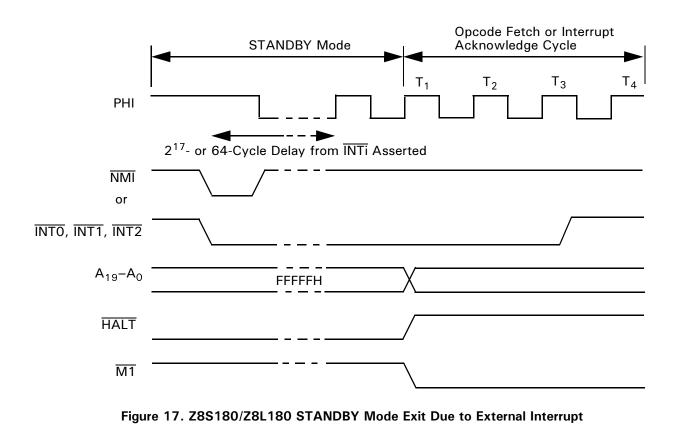
an external request on $\overline{\text{NMI}}$, or an external request on $\overline{\text{INTO}}$, $\overline{\text{INT1}}$, or $\overline{\text{INT2}}$.

If an interrupt source is individually disabled, it cannot bring the Z8S180/Z8L180 out of SLEEP mode. If an interrupt source is individually enabled, and the IEF bit is 1 so that interrupts are globally enabled (by an EI instruction), the highest priority active interrupt occurs with the return address being the instruction after the SLP instruction. If an interrupt source is individually enabled, but the IEF bit is 0 so that interrupts are globally disabled (by a DI instruction), the Z8S180/Z8L180 leaves SLEEP mode by simply executing the following instruction(s). ing the bus to an external Master during STANDBY mode, when the BREXT bit in the CPU Control Register (CCR5) is 1.

As described previously for SLEEP and IDLE modes, when the MPU leaves STANDBY mode due to $\overline{\text{NMI}}$ Low or an enabled $\overline{\text{INTO}}$ - $\overline{\text{INT2}}$ Low when the IEF, flag is 1 due to an IE instruction, it starts by performing the interrupt with the return address being that of the instruction following the SLP instruction. If the Z8S180/Z8L180 leaves STANDBY mode due to an external interrupt request that's enabled in the INT/TRAP Control Register, but the IEF, bit is 0 due to a DI instruction, the processor restarts by executing the instruction(s) following the SLP instruction. If \overline{INTO} , or $\overline{INT1}$ or $\overline{INT2}$ goes inactive before the end of the clock stabilization delay, the Z8S180/Z8L180 stays in STANDBY mode.

Figure 17 indicates the timing for leaving STANDBY mode due to an interrupt request.

Note: The Z8S180/Z8L180 takes either 64 or 2^{17} (131,072) clocks to restart, depending on the CCR3 bit.



While the Z8S180/Z8L180 is in STANDBY mode, it grants the bus to an external Master if the BREXT bit (CCR5) is 1. Figure 18 indicates the timing of this sequence. The device takes 64 or 2^{17} (131,072) clock cycles to grant the bus depending on the CCR3 bit. The latter (not the QUICK RE-COVERY) case may be prohibitive for many demand-driven external Masters. If so, QUICK RECOVERY or IDLE mode can be used.

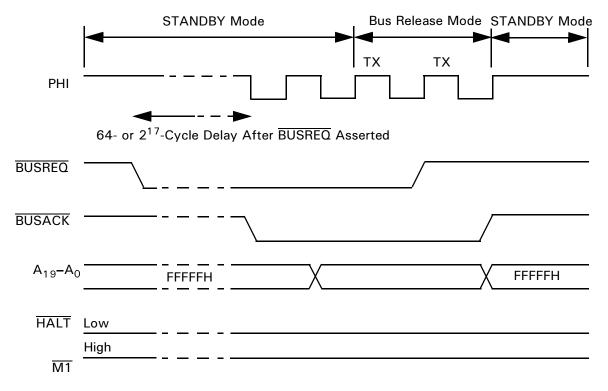


Figure 18. Bus Granting to External Master During STANDBY Mode

DC CHARACTERISTICS-Z8S180

Table 6.	Z8S1	80 DC (Charact	eristics
V_{DD}	= 5V	±10%;	$V_{SS} =$	0V

Symbol	ltem	Condition	Min	Тур	Max	Unit
V _{IH1}	Input H Voltage RESET, EXTAL, NMI		V _{DD} -0.6	_	V _{DD} +0.3	V
V _{IH2}	Input H Voltage Except RESET, EXTAL, NMI		2.0	_	V _{DD} +0.3	V
V _{IH3}	Input H Voltage CKS, CKA0, CKA1		2.4	—	V _{DD} +0.3	V
V _{IL1}	Input L Voltage RESET, EXTAL, NMI		-0.3	_	0.6	V
V _{IL2}	Input L Voltage Except RESET, EXTAL, NMI		-0.3	_	0.8	V
V _{OH}	Outputs H Voltage	I _{OH} = -200 μA	2.4	_	_	V
	All outputs	$I_{OH} = -20 \ \mu A$	V _{DD} –1.2		_	
V _{OL}	Outputs L Voltage All outputs	$I_{OL} = 2.2 \text{ mA}$	_	_	0.45	V
I _{IL}	Input Leakage Current All Inputs Except XTAL, EXTAL	$V_{\rm IN} = 0.5 \sim V_{\rm DD} - 0.5$	-	_	1.0	μA
I _{TL}	Three State Leakage Current	$V_{IN} = 0.5 \sim V_{DD} - 0.5$	_	_	1.0	μA
I _{DD} ¹	Power Dissipation	F = 10 MHz	—	25	60	mA
00	(Normal Operation)	20		30	50	
		33		60	100	
	Power Dissipation	F = 10 MHz	_	2	5	
	(SYSTEM STOP mode)	20		3	6	
		33		5	9	
C _P	Pin Capacitance	$V_{ N} = O_V, f = 1 MHz$ $T_A = 25^{\circ}C$	—	_	12	pF

			Z8S180-	—20 MHz	Z8S180-	–33 MHz	
Number	Symbol	Item	Min	Max	Min	Max	Unit
63	t _{REH}	RESET Hold Time from PHI Fall	25	_	15	_	ns
64	t _{osc}	Oscillator Stabilization Time	_	20	_	20	ns
65	t _{EXR}	External Clock Rise Time (EXTAL)	_	5		5	ns
66	t _{EXF}	External Clock Fall Time (EXTAL)	_	5	_	5	ns
67	t _{RR}	RESET Rise Time	—	50		50	ms
68	t _{RF}	RESET Fall Time	—	50		50	ms
69	t _{IR}	Input Rise Time (except EXTAL, RESET)	_	50		50	ns
70	t _{IF}	Input Fall Time (except EXTAL, RESET)	—	50	—	50	ns

Table 8. Z8S180 AC Characteristics (Continued) $V_{DD} = 5V \pm 10\%$ or $V_{DD} = 3.3V \pm 10\%$; 33-MHz Characteristics Apply Only to 5V Operation

ASCI CHANNEL CONTROL REGISTER A (Continued)

vious contents of TDRE are held. TE is cleared to 0 in IOSTOP mode during RESET.

RTSO: Request to Send Channel 0 (Bit 4 in CNTLA0 Only). If bit 4 of the System Configuration Register is 0, the RTSO/TXS pin exhibits the RTSO function. RTSO allows the ASCI to control (start/stop) another communication devices transmission (for example, by connecting to that device's \overline{CTS} input). RTSO is essentially a 1-bit output port, having no side effects on other ASCI registers or flags.

Bit 4 in CNTLA1 is used.

 $CKA1D = 1, CKA1/\overline{TEND0} pin = \overline{TEND0}$

 $CKA1D = 0, CKA1/\overline{TEND0} pin = CKA1$

These bits are cleared to 0 on reset.

MPBR/EFR: Multiprocessor Bit Receive/Error Flag Reset (Bit 3). When multiprocessor mode is enabled (MP in CNTLB = 1), MPBR, when read, contains the value of the MPB bit for the most recent receive operation. When written to 0, the EFR function is selected to reset all error flags (OVRN, FE, PE and BRK in the ASEXT Register) to 0. MPBR/EFR is undefined during RESET.

MOD2, 1, 0: ASCI Data Format Mode 2,1,0 (bits 2-0).

These bits program the ASCI data format as follows.

MOD2

- $= 0 \rightarrow 7$ bit data
- $= 1 \rightarrow 8$ bit data

MOD1

- $= 0 \rightarrow No parity$
- = 1→Parity enabled

MOD0

= $0 \rightarrow 1$ stop bit = $1 \rightarrow 2$ stop bits

The data formats available based on all combinations of MOD2, MOD1, and MOD0 are indicated in Table 9.

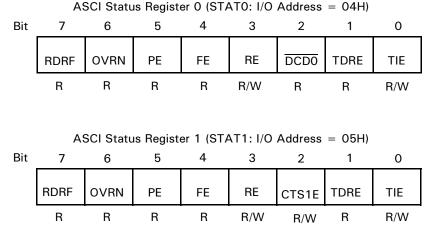
Table 9. Data Formats

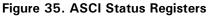
MOD2	MOD1	MOD0	Data Format
0	0	0	Start + 7 bit data + 1 stop
0	0	1	Start + 7 bit data + 2 stop
0	1	0	Start + 7 bit data + parity + 1 stop
0	1	1	Start + 7 bit data + parity + 2 stop
1	0	0	Start + 8 bit data + 1 stop
1	0	1	Start + 8 bit data + 2 stop
1	1	0	Start + 8 bit data + parity + 1 stop
1	1	1	Start + 8 bit data + parity + 2 stop

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ASCI STATUS REGISTER 0,1

Each ASCI channel status register (STAT0,1) allows interrogation of ASCI communication, error and modem control signal status, and the enabling or disabling of ASCI interrupts.





RDRF: Receive Data Register Full (Bit 7). RDRF is set to 1 when an incoming data byte is loaded into an empty Rx FIFO. If a framing or parity error occurs, RDRF is still set and the receive data (which generated the error) is still loaded into the FIFO. RDRF is cleared to 0 by reading RDR and most recently received character in the FIFO from IOSTOP mode, during RESET and for ASCI0 if the DCD0 input is auto-enabled and is negated (High).

OVRN: Overrun Error (Bit 6). An overrun condition occurs if the receiver finishes assembling a character but the Rx FIFO is full so there is no room for the character. However, this status bit is not set until the most recent character received before the overrun becomes the oldest byte in the FIFO. This bit is cleared when software writes a 1 to the EFR bit in the CNTLA register. The bit may also be cleared by RESET in IOSTOP mode or ASCIO if the DCDO pin is auto enabled and is negated (High).

Note: When an overrun occurs, the receiver does not place the character in the shift register into the FIFO, nor any subsequent characters, until the most recent good character enters the top of the FIFO so that OVRN is set. Software then writes a 1 to EFR to clear it.

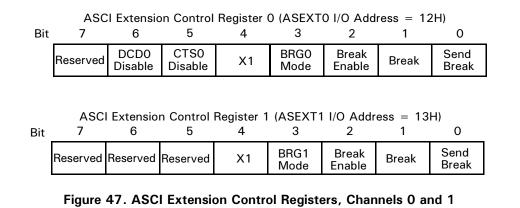
PE: Parity Error (Bit 5). A parity error is detected when parity checking is enabled. When the MOD1 bit in the

CNTLA register is 1, a character is assembled in which the parity does not match the PEO bit in the CNTLB register. However, this status bit is not set until or unless the error character becomes the oldest one in the Rx FIFO. PE is cleared when software writes a 1 to the EFR bit in the CNTRLA register. PE is also cleared by RESET in IOSTOP mode, or on ASCIO, if the DCDO pin is auto-enabled and is negated (High).

FE: Framing Error (Bit 4). A framing error is detected when the stop bit of a character is sampled as O/SPACE. However, this status bit is not set until/unless the error character becomes the oldest one in the Rx FIFO. FE is cleared when software writes a 1 to the EFR bit in the CNTLA register. FE is also cleared by RESET in IOSTOP mode, or on ASCIO, if the DCDO pin is auto-enabled and is negated (High).

REI: Receive Interrupt Enable (Bit 3). RIE should be set to 1 to enable ASCI receive interrupt requests. When RIE is 1, the Receiver requests an interrupt when a character is received and RDRF is set, but only if neither DMA channel requires its request-routing field to be set to receive data from this ASCI. That is, if SM1–0 are 11 and SAR17–16 are 10, or DIM1 is 1 and IAR17–16 are 10, then ASCI1 does not request an interrupt for RDRF. If RIE is 1, either ASCI requests an interrupt when OVRN, PE or FE is set, and The ASCI Extension Control Registers (ASEXTO and ASEXT1) control functions that have been added to the

ASCIs in the Z8S180/Z8L180 family. All bits in this register reset to 0.



DCD0 Disable (Bit 6, ASCIO Only). If this bit is 0, then the $\overline{\text{DCD0}}$ pin auto-enables the ASCIO receiver, such that when the pin is negated/High, the Receiver is held in a RE-SET state. If this bit is 1, the state of the $\overline{\text{DCD}}$ -pin has no effect on receiver operation. In either state of this bit, software can read the state of the $\overline{\text{DCD0}}$ pin in the STATO register, and the receiver interrupts on a rising edge of $\overline{\text{DCD0}}$.

CTSO Disable (Bit 5, ASCIO Only). If this bit is 0, then the $\overline{\text{CTSO}}$ pin auto-enables the ASCIO transmitter, in that when the pin is negated/High, the TDRE bit in the STATO register is forced to 0. If this bit is 1, the state of the $\overline{\text{CTSO}}$ pin has no effect on the transmitter. Regardless of the state of this bit, software can read the state of the $\overline{\text{CTSO}}$ pin the CNTLBO register.

X1 (Bit 4). If this bit is 1, the clock from the Baud Rate Generator or CKA pin is taken as a 1X-bit clock (sometimes called *isochronous mode*). In this mode, receive data on the RXA pin must be synchronized to the clock on the CKA pin, regardless of whether CKA is an input or an output. If this bit is 0, the clock from the Baud Rate Generator or CKA pin is divided by 16 or 64 per the DR bit in the CNTLB register, to obtain the actual bit rate. In this mode, receive data on the RXA pin is not required to be synchronized to a clock.

BRG Mode (Bit 3). If the SS2–0 bits in the CNTLB register are not 111, and this bit is 0, the ASCI Baud Rate Generator

divides PHI by 10 or 30, depending on the PS bit in CNTLB, and factored by a power of two (selected by the SS2–0 bits), to obtain the clock that is presented to the transmitter and receiver and output on the CKA pin. If SS2–0 are not 111, and this bit is 1, the Baud Rate Generator divides PHI by twice the sum of the 16-bit value (programmed into the Time Constant registers) and 2. This mode is identical to the operation of the baud rate generator in the ESCC.

Break Enable (Bit 2). If this bit is 1, the receiver detects BREAK conditions and report them in bit 1, and the transmitter sends BREAKs under the control of bit 0.

Break Detect (Bit 1). The receiver sets this read-only bit to 1 when an all-zero character with a Framing Error becomes the oldest character in the Rx FIFO. The bit is cleared when software writes a 0 to the EFR bit in CNTLA register, also by RESET, by IOSTOP mode, and for ASCIO, if the DCDO pin is auto-enabled and is negated (High).

Send Break (Bit 0). If this bit and bit 2 are both 1, the transmitter holds the TXA pin Low to send a BREAK condition. The duration of the BREAK is under software control (one of the PRTs or CTCs can be used to time it). This bit resets to 0, in which state TXA carries the serial output of the transmitter.

ASCI TIME CONSTANT REGISTERS

If the SS2–0 bits of the CNTLB register are not 111, and the BRG mode bit in the ASEXT register is 1, the ASCI divides the PHI clock by two times the registers' 16-bit value, plus two. As a result, the clock is presented to the transmitter and receiver for division by 1, 16, or 64, and is output on the CKA pin.

If the SS2–0 bits in an ASCI CNTLB register are not 111, and the BRG mode bit in its Extension Control Register is 1, its *new* baud rate generator divides PHI for serial clocking, as follows:

bits/second =
$$f_{PHI}/(2*(TC+2) \times sampling rate)$$

where TC is the 16-bit value programmed into the ASCI Time Constant High and Low registers. If the ASCI multiplexed CKA pin is selected for the CKA function, it outputs the clock before the final division by the sampling rate, as follows:

$$f_{CKAout} = f_{PHI}/(2*(TC+2))$$

Find the TC value for a particular serial bit rate as follows:

 $TC = (f_{PHI}/(2 \text{ x bits/second x sampling rate})) - 2$

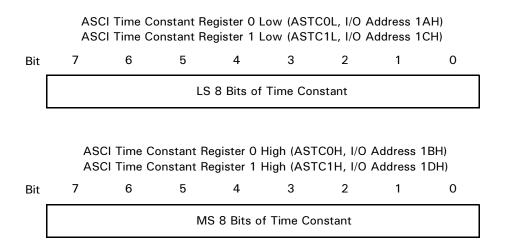


Figure 53. ASCI Time Constant Registers

CLOCK MULTIPLIER REGISTER

(Z180 MPU Address 1EH)

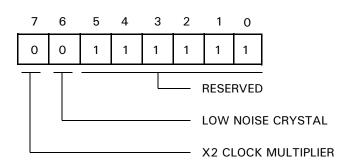


Figure 54. Clock Multiplier Register

Bit 7. X2 Clock Multiplier Mode. When this bit is set to 1, the programmer can double the internal clock speed from the speed of the external clock. This feature only operates effectively with frequencies of 10-16 MHz (20-32 MHz internal). When this bit is set to 0, the Z8S180/Z8L180 device operates in normal mode. At power-up, this feature is disabled.

Bit 6. Low Noise Crystal Option. Setting this bit to 1 enables the low-noise option for the EXTAL and XTAL pins. This option reduces the gain in addition to reducing the output drive capability to 30% of its original drive capability. The Low Noise Crystal Option is recommended in the use of crystals for PCMCIA applications, where the crystal may be driven too hard by the oscillator. Setting this bit to 0 is selected for normal operation of the EXTAL and XTAL pins. The default for this bit is 0.

Note: Operating restrictions for device operation are listed below. If a low-noise option is required, and normal device operation is required, use the clock multiplier feature.

Table 13. Low Noise Option

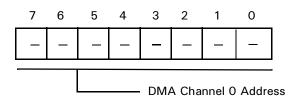
Low Noise ADDR 1E, bit 6 = 1	Normal ADDR 1E, bit 6 = 0
20 MHz @ 4.5V, 100°C	33 MHz @ 4.5V, 100°C
10 MHz @ 3.0V, 100°C	20 MHz @ 3.0V, 100°C

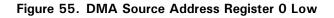
DMA SOURCE ADDRESS REGISTER CHANNEL 0

The DMA Source Address Register Channel 0 specifies the physical source address for channel 0 transfers. The register contains 20 bits and can specify up to 1024 KB memory addresses or up to 64-KB I/O addresses. Channel 0 source can be memory, I/O, or memory mapped I/O. For I/O, bits 17–16 of this register identify the Request Handshake signal.

DMA Source Address Register, Channel 0 Low

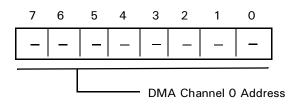
Mnemonic SAR0L Address 20H





DMA Source Address Register, Channel 0 High

Mnemonic SAR0H Address 21H





DMA Source Address Register Channel OB

Mnemonic SAR0B Address 22H

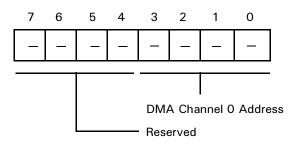


Figure 57. DMA Source Address Register 0B

If the source is in I/O space, bits 1–0 of this register select the DMA request signal for DMA0, as follows:

Bit 1 (A17)	Bit 0 (A16)	DMA Transfer Request
0	0	DREQ0 (external)
0	1	RDRF (ASCIO)
1	0	RDRF (ASCI1)
1	1	Reserved

DMA MEMORY ADDRESS REGISTER CHANNEL 1

The DMA Memory Address Register Channel 1 specifies the physical memory address for channel 1 transfers. The address may be a destination or a source memory location. The register contains 20 bits and may specify up to 1024 KB memory addresses.

DMA Memory Address Register, Channel 1L

Mnemonic MAR1L Address 28H

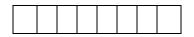


Figure 65. DMA Memory Address Register, Channel 1L

DMA Memory Address Register, Channel 1H

Mnemonic MAR1H Address 29H



Figure 66. DMA Memory Address Register, Channel 1H

DMA Memory Address Register, Channel 1B

Mnemonic MAR1B Address 2AH

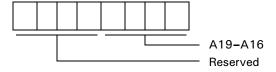


Figure 67. DMA Memory Address Register, Channel 1B

DMA/WAIT CONTROL REGISTER

The DMA/WAIT Control Register (DCNTL) controls the insertion of wait states into DMAC (and CPU) accesses of memory or I/O. Also, the register defines the Request signal

for each channel as level or edge sense. DCNTL also sets the DMA transfer mode for channel 1, which is limited to memory to/from I/O transfers.

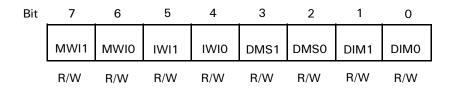


Figure 73. DMA/WAIT Control Register (DCNTL: I/O Address = 32H)

MWI1, MWI0: Memory Wait Insertion (Bits 7–6). This bit specifies the number of wait states introduced into CPU or DMAC memory access cycles. MWI1 and MWI0 are set to 1 during RESET.

MWI1	MWIO	Wait State
0	0	0
0	1	1
1	0	2
1	1	3

IWI1, IWI0: I/O Wait Insertion (Bits 5–4). This bit specifies the number of wait states introduced into CPU or DMAC I/O access cycles. IWI1 and IWI0 are set to 1 during RESET.

IWI1	IWIO	Wait State
0	0	1
0	1	2
1	0	3
1	1	4

Note: These wait states are added to the 3-clock I/O cycle that is used to access the on-chip I/O registers. It is equally valid to regard these as 0 to 3 wait states added to a 4-clock external I/O cycle.

DMS1, DMS0: DMA Request Sense (Bits 3–2). DMS1 and DMS0 specify the DMA request sense for channel 0 and channel 1 respectively. When reset to 0, the input is level sense. When set to 1, the input is edge sense. DMS1 and DMS0 are cleared to 0 during RESET.

DMSi	Sense
1	Edge Sense
0	Level Sense

Typically, for an input/source device, the associated DMS bit should be programmed as 0 for level sense. The device takes a relatively long time to update its Request signal after the DMA channel reads data (in the first of the two machine cycles involved in transferring a byte).

An output/destination device takes much less time to update its Request signal after the DMA channel starts a WRITE operation to it (the second machine cycle of the two cycles involved in transferring a byte). With zero-wait state I/O cycles, a device cannot update its request signal in the required time, so edge sensing must be used.

A one-wait-state I/O cycle also does not provide sufficient time for updating, so edge sensing is again required.

DIM1, DIMO: DMA Channel 1 I/O and Memory Mode (Bits 1–0). Specifies the source/destination and address modifier for channel 1 memory to/from I/O transfer modes. DIM1 and DIMO are cleared to 0 during RESET.

Table 17. Channel 1 Transfer Mode

DIM1	DMI0	Transfer Mode	Address Increment/Decrement
0	0	Memory→I/O	MAR1 +1, IAR1 fixed
0	1	Memory→I/O	MAR1 -1, IAR1 fixed
1	0	I/O→Memory	IAR1 fixed, MAR1 +1
1	1	I/O→Memory	IAR1 fixed, MAR1 -1

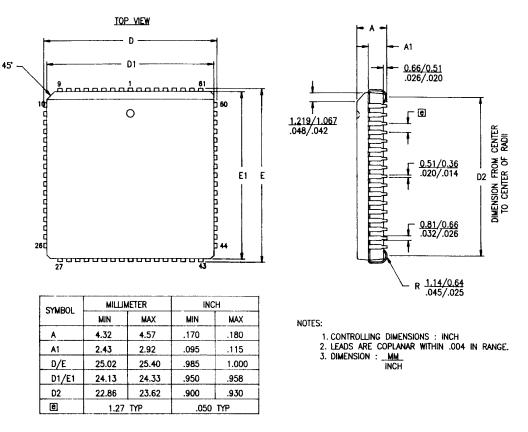


Figure 87. 68-Pin PLCC Package Diagram